

< X/Ku band internally matched power GaAs FET >

MGFK25V4045

14.0 - 14.5 GHz BAND / 0.3W

DESCRIPTION

The MGFK25V4045 is an internally impedance-matched GaAs power FET especially designed for use in 14.0 - 14.5 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

FEATURES

Internally matched to 50(ohm) system Flip-chip mounted

- High output power
- PĭdB=0.3W (TYP.) @f=14.0 − 14.5GHz • High linear power gain
- GLP=9.0dB (TYP.) @f=14.0 14.5GHz • High power added efficiency
- P.A.E.=25% (TYP.) @f=14.0 14.5GHz

APPLICATION

• 14.0 - 14.5 GHz band power amplifiers

QUALITY GRADE

• IG



• VDS=8V • ID=80mA Refer to Bias Procedure

Absolute maximum ratings (Ta=25°C)

Symbol	Parameter	Ratings	Unit
VGDO	Gate to drain breakdown voltage	-15	V
VGSO	Gate to source breakdown voltage	-15	V
ID	Drain current	500	mA
IGR	Reverse gate current	-1	mA
IGF	Forward gate current	1	mA
PT *1	Total power dissipation	2.7	W
Tch	Cannel temperature	175	°C
Tstg	Storage temperature	-65 to +175	°C

*1 : Tc=25°C

Electrical characteristics (Ta=25°C)

freq (1) = 110 + 103

Unit : millimeters

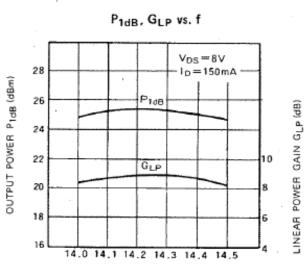
OUTLINE DRAWING

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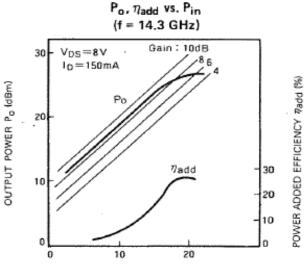
Symbol	Parameter	Test conditions		Limits		
			Min.	Тур.	Max.	
IDSS	Saturated drain current	VDS=3V,VGS=0V	-	200	500	mA
gm	Transconductance	VDS=3V,ID=150mA	-	100	-	mS
VGS(off)	Gate to source cut-off voltage	VDS=3V,ID=1mA	-2	-	-5	V
P1dB	Output power at 1dB gain compression	VDS=8V,ID(RF off)=150mA	23	26	-	dBm
GLP	Linear Power Gain	f=14.0 – 14.5GHz	7	9	-	dB
PAE	Power added efficiency	7	-	25	-	%
Rth(ch-c) *2	Thermal resistance	delta Vf method	-	-	40	°C/W

*2 : Channel-case

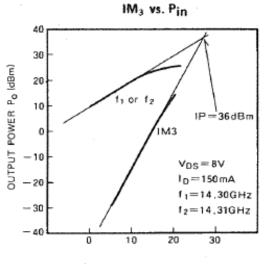
MGFK25V4045 TYPICAL CHARACTERISTICS







INPUT POWER Pin (dBm)



INPUT POWER Pin (dBm)

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